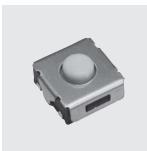
SMT3/SMTE3

Surface Mount Tactile Switches

Washable



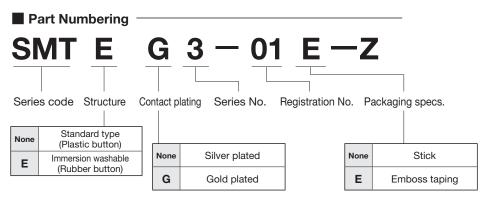
RoHS Compliant

Features -

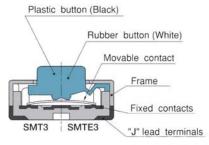
- 1. Compatible With Lead-Free, Reflow Soldering Heat-resistance resin for lead-free soldering.
- 2. Washable (SMTE3 Series)
- 3. J-Lead Terminal Pins For High-Density Mounting
- 4. Anti-Static Electricity (SMTE3 Series) Ground terminal is provided to prevent damage to element caused by static electricity.

Specifications

	Max.	0.6VA max. (24VDC max. 30mA max.)	
Rating	Min.	Silver plated contacts	1mA DC5V
		Gold plated contacts	10μA DC5V
Initial contact resistance		100m Ω max. (1	.5mA 200µVAC)
Dielectric strength		250VAC 1 minute	
Insulation resistance		100M Ω min.	(100VDC)
Electrostatic capacity		5pF max.	
Electrical life		100,000 operations	
Stroke	SMT3	0.25mm	
Stroke	SMTE3	0.5mm	
Operating force	SMT3	1.18±0.39 N	
	SMTE3	1.96±0.98 N	
Operating temperature range		-25~+70°C	
Storage temperature range		-40~+85°C	







■ Table of Part Numbers

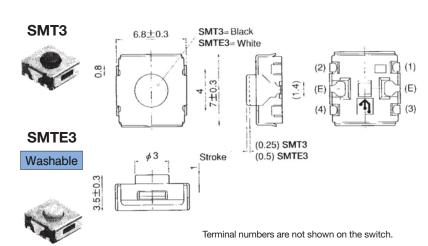
Churchine	Packaging specifications	
Structure	Stick	Emboss taping
Standard type	SMT3-01-Z	SMT3-01E-Z ★SMTG3-01E-Z
Immersion washable	SMTE3-01-Z ★SMTEG3-01-Z	SMTE3-01E-Z ★SMTEG3-01E-Z

Pad Layouts

(Top view)

		(10p vicw)
Ground terminals	Without	With
Part No.	SMT3 · SMTE3 SMTG3 · SMTEG3	SMTE3 SMTEG3
Pattern dimensions	3.2 3.6 3.2	3.2 3.6 3.2 (1) (2) (E) (E) (E) (4)

SPST



	Switchng function		
Part No.	_	Push	
SMT3-01-Z SMT3-01E-Z SMTG3-01E-Z SMTE3-01-Z SMTE3-01E-Z SMTEG3-01-Z SMTEG3-01E-Z	OFF	(ON)	
Connecting terminals		$\frac{1}{2} - \frac{3}{4}$	
Circuit diagrams	(1) 0 (2)		
(ON): Mamantary	(E) (E)		

(ON): Momentary

(E): GGround terminal (SMTE3 and SMTEG3 series)

■Soldering Specifications -

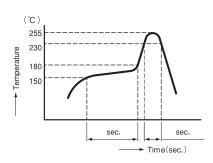
(1) Manual Soldering

Device : Soldering iron

 1350° C $\pm 10^{\circ}$ C; 3 ± 0.5 seconds

(2)Reflow Soldering

Device: Inline or batch system



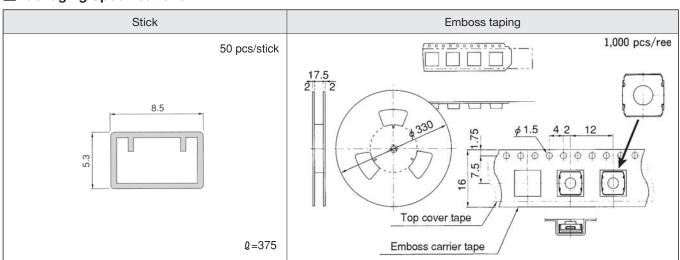
Apply reflow soldering up to 2 times max.

Flux Cleaning -

Since the **SMT3** series is not process sealed, be sure to use low-residue flux.

- (1) Solvent: Fluorine or Alcohol type
 - Cleaning with other solvents or water is not possible.
- (2) Cleaning after soldering should be done after the terminal temperature falls to 90°C or below, or after leaving the switch for five minutes or longer at room temperature. Cleaning temperature: 43°C, max.
- (3) Do not use ultrasonic cleaning.

■ Packaging Specifications



When ordering, tape packaged version shall be supplied by request. Minimum packaging quantity for reel packaging is 1,000pcs per reel.